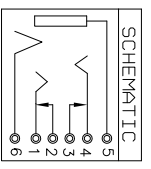
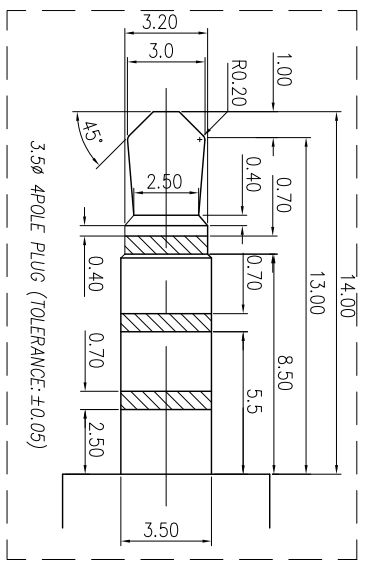
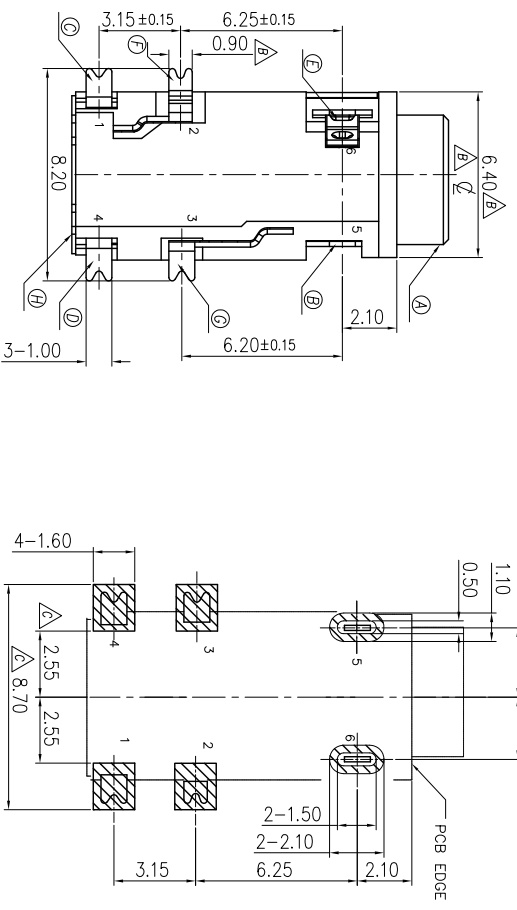
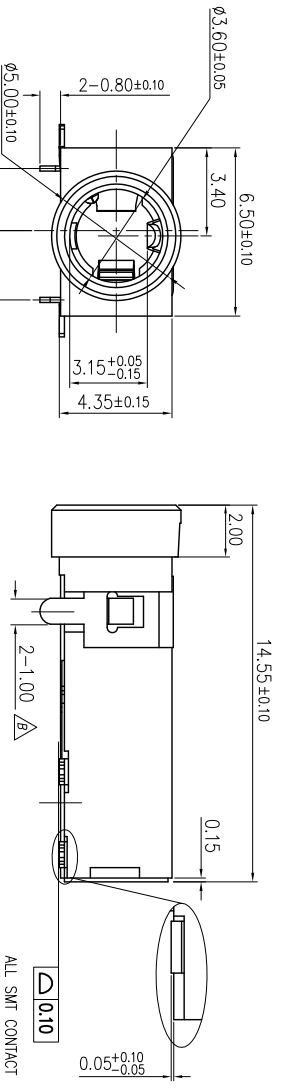
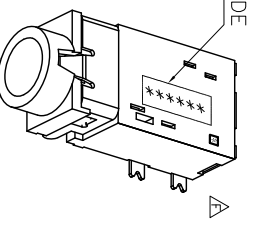


REV.	EGN NO OR DESCRIPTION	REVISED	DATE
D	ECN: C110167 Modify Plating	LONGJIANG	2011.05.24
E	ECN: C110298 Modify life test cycles	LONGJIANG	2011.11.18
F	ECR: C130269 UPDATE DRAWING	TFY	2014.4.21



RECOMMENDED P.C.B. LAYOUT
TOP VIEW (TOLERANCE: ±0.05)



- DATE CODE
- SPECIFICATIONS:
- ELECTRICAL CHARACTERISTICS:
 - RATING: 12V 1A
 - CONTACT RESISTANCE: 30mΩ MAX (INITIAL)
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 500 VDC
 - MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE : 0.3~3.0 KGf
 - WITHDRAWAL FORCE : 0.3~3.0 KGf
 - LIFE TEST: 5,000 CYCLES MIN.
 - OTHER GENERAL SPEC. TO REFER "2SJ2269 SERIES SPEC".
 - TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
 - GREEN PRODUCT IDENTIFICATION MARK ON JACK:
 - GREEN PRODUCT IDENTIFICATION LABEL ON PACKAGING: **G.P. PASS**
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
H	COVER	1	COPPER ALLOY 0.2t	NI
G	SHUNT-B	1	COPPER ALLOY 0.2t	GOLD FLASH
F	SHUNT-A	1	COPPER ALLOY 0.2t	GOLD FLASH
E	RING SPRING-B	1	COPPER ALLOY 0.2t	GOLD FLASH
D	RING SPRING-A	1	COPPER ALLOY 0.2t	<i>Gold Flush on contact area And solder area, all over Nickel plating</i>
C	TIP SPRING	1	COPPER ALLOY 0.2t	
B	EARTH SPRING	1	COPPER ALLOY 0.2t	GOLD FLASH
A	BODY	1	HIGH TEMP. THERMOPLASTIC	BLACK

UNLESS OTHERWISE SPECIFIED TOLERANCES

Singatron Enterprise Co., Ltd.
信登企業股份有限公司

DECIMALS:	ANGLES:
X : ±0.5	X : ±2°
X.X : ±0.3	X.X : ±1°
X.XX : ±0.2	

TITLE	PART NO.	UNIT	REVISION
3.5Ø PHONE JACK	2SJ2269-202111	mm	F

APVD: 14/4/29 SIZE: A3 SHEET: 10F1

CUSTOMER COPY